



DATA SHEET

HIGH CURRENT ZERO OHM JUMPER PA series

sizes 0100/ 0201/ 0402/ 0603/ 0805/ 1206/ 2010

RoHS compliant & Halogen free

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0755-28100016





SCOPE

This specification describes PA0100~2010 series jumper with metal alloy layer.

APPLICATIONS

- Consumer goods
- Computer
- Telecom / Datacom
- Industrial / Power supply
- Alternative Energy
- Car electronics

FEATURES

- PA Jumper resistors are designed to be used as a zero ohm jumper
- AEC-Q200 qualified
- Halogen-free Epoxy
- RoHS compliant
- Reduce environmentally hazardous wastes
- High component and equipment reliability
- Non-forbidden materials used in products/production
- High current capability
- Moisture sensitivity level: MSL 1

ORDERING INFORMATION - GLOBAL PART NUMBER

Global part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

GLOBAL PART NUMBER

PA **XXXX** **X** **X** **X** **XX** **OR** **L**
 (1) (2) (3) (4) (5) (6) (7)

(1) SIZE

0100 / 0201 / 0402 / 0603 / 0805 / 1206 / 2010

(2) TOLERANCE

-

(3) PACKAGING TYPE

R = Paper taping reel (PA0100~1206)
 K = Embossed taping reel (PA2010)

(4) TEMPERATURE COEFFICIENT OF RESISTANCE

-

(5) TAPING REEL

07 = 7 inch dia. Reel
 7W = 7 inch dia. Reel, (0402 only)
 47 = 7 inch dia. Reel, (0805 only)

(6) RESISTANCE VALUE

0R = 0 Ω

(7) DEFAULT CODE

Letter L is the system default code for ordering only. (Note)

Resistance rule of global part number

Resistance code rule	Example
0R (0 Ω)	0R = 0 Ω

ORDERING EXAMPLE

The ordering code for a PA0603 chip resistor, value 0 Ω, supplied in 7-inch tape reel with 5Kpcs quantify is: PA0603-R-070RL.

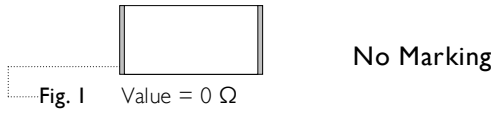
NOTE

1. All our RChip products are RoHS compliant. "LFP" of the internal 2D reel label mentions "Lead-Free Process"



MARKING

PA0201



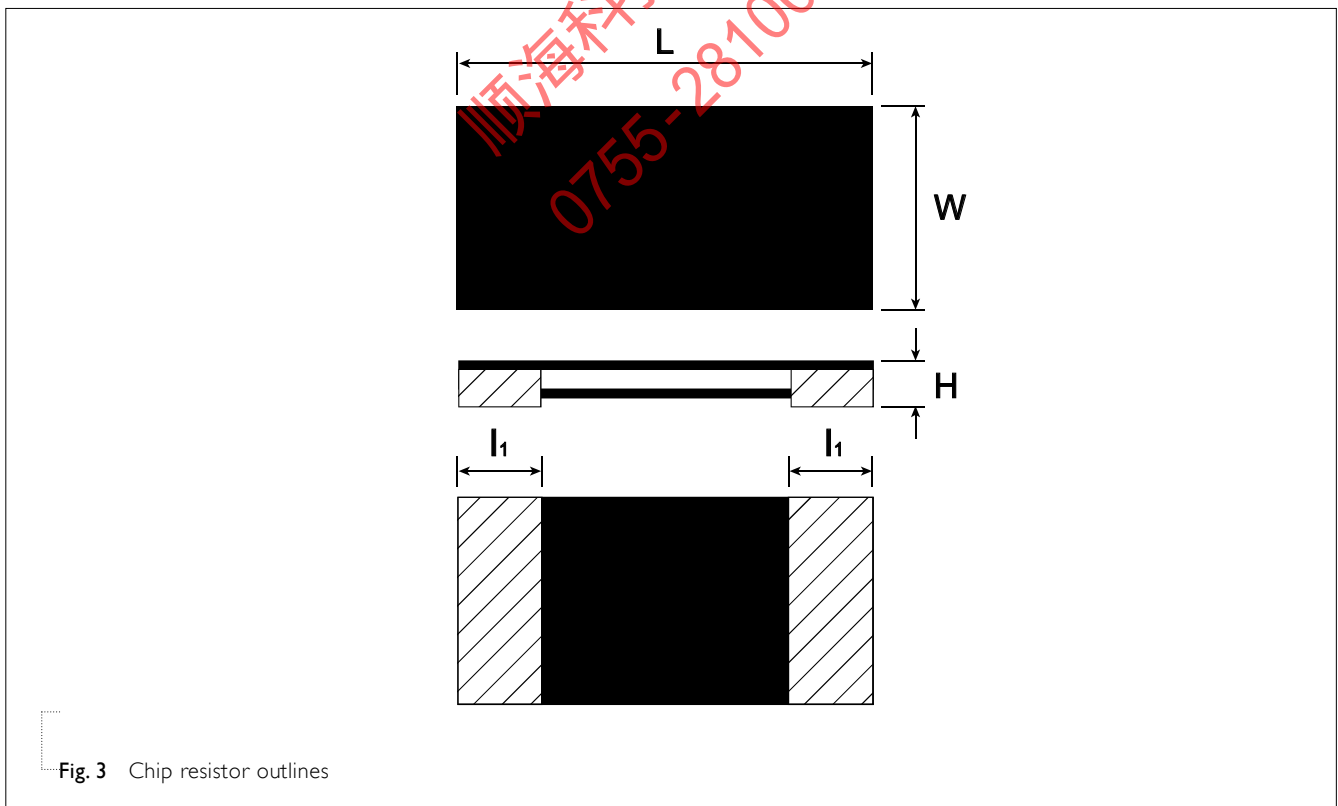
PA0100 / 0402 / 0603 / 0805 / 1206 / 2010



CONSTRUCTION

The advanced resistive material is adopted to get the low resistance and is covered with a protective coat. Finally, the three external terminations (Cu / Ni / matte Tin) are added, as shown in Fig. 3.

Outlines





DIMENSION

Table 1 For outlines, please refer to Fig. 3

TYPE	L (mm)	W (mm)	H (mm)	l ₁ (mm)
PA0100	0.40±0.03	0.20±0.03	Max. 0.15	0.10±0.03
PA0201	0.60±0.03	0.31±0.04	Max. 0.35	0.15±0.06
PA0402	1.00±0.10	0.55±0.10	Max. 0.35	0.25±0.10
PA0603	1.60±0.20	0.8+0.10/-0.20	0.45±0.15	0.38±0.12
PA0805	2.00±0.15	1.20±0.15	Max. 0.40	0.35±0.25
PA1206	3.05±0.20	1.52±0.20	0.50±0.20	0.70±0.20
PA2010	5.08±0.20	2.54±0.20	0.40±0.15	0.70±0.20

Note:

1. For relevant physical dimensions, please refer to construction outlines.
2. Please contact with sales offices, distributors and representatives in your region before ordering.

ELECTRICAL CHARACTERISTICS

Table 2

		PA0100	PA0201	PA0402		PA0603	PA0805	PA1206	PA2010
Jumper Criteria	Resistance Value, Max. (mΩ)	<2mΩ	<5mΩ	<1mΩ	<0.2mΩ	<0.2mΩ	<0.5mΩ	≤0.2mΩ	≤0.2mΩ
	Rated Current (A)	8	4.5	11	23	50	20	70.7	100
	Rated Power (W)	1/8	1/10	1/8	1/10	1/2	1/5	1	2
Operating Temperature Range		-55°C to +125°C				-55°C to +155°C		-55°C to +170°C	

Note: Please contact with sales offices, distributors and representatives in your region before ordering.

FUNCTIONAL DESCRIPTION

OPERATING TEMPERATURE RANGE

PA0100 to PA0402: -55°C to +125°C

PA0603/ PA0805: -55°C to +155°C

PA1206/ PA2010: -55°C to +170°C

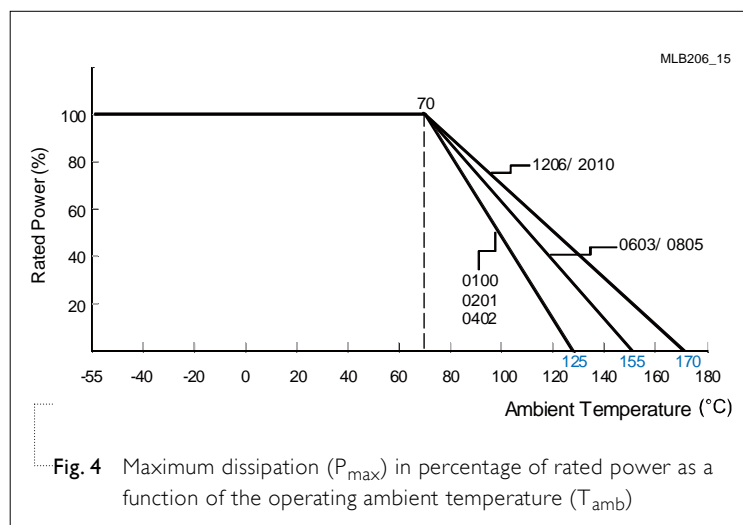


Fig. 4 Maximum dissipation (P_{max}) in percentage of rated power as a function of the operating ambient temperature (T_{amb})



PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	PA0100	PA0201	PA0402	PA0603	PA0805	PA1206	PA2010
Paper taping reel (R)	7" (178 mm)	20,000	10,000	10,000	5,000	5,000	4000	---
Embossed Taping Reel (K)	7" (178 mm)	---	---	---	---	---	---	4000

PAPER TAPE

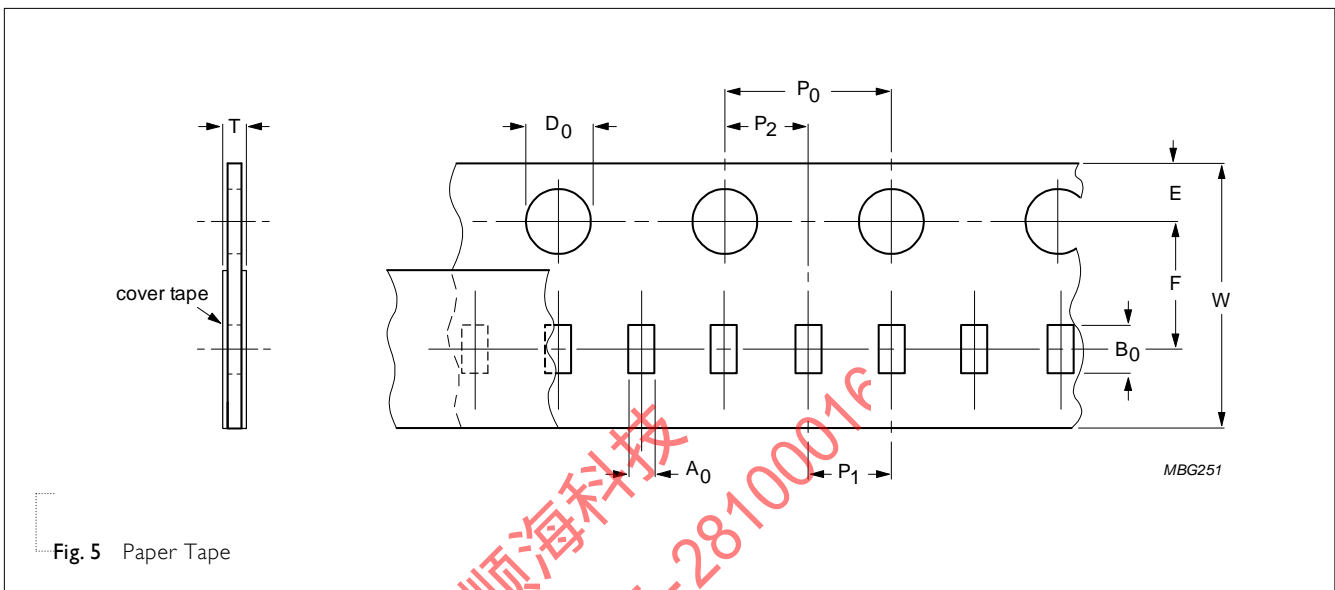


Fig. 5 Paper Tape

Table 4 Dimensions of paper tape for relevant chip resistors size

SIZE	SYMBOL										Unit: mm
	A ₀	B ₀	W	E	F	P ₀	P ₁	P ₂	ØD ₀	T	
PA0100	0.24±0.03	0.45±0.03	8.00±0.20	1.75±0.10	3.50±0.05	4.00±0.05	2.00±0.10	2.00±0.05	1.50±0.10	0.31±0.10	
PA0201	0.38±0.10	0.68±0.10	8.00±0.10	1.75±0.10	3.50±0.10	4.00±0.10	2.00±0.10	2.00±0.10	1.55±0.05	0.42±0.10	
PA0402	0.59±0.10	1.20±0.10	8.00±0.10	1.75±0.10	3.50±0.10	4.00±0.10	2.00±0.10	2.00±0.10	1.55±0.05	0.45±0.10	
PA0603	1.10±0.10	1.90±0.10	8.00±0.10	1.75±0.10	3.50±0.10	4.00±0.10	4.00±0.10	2.00±0.10	1.55±0.05	0.43±0.10	
PA0805	1.62±0.10	2.35±0.10	8.00±0.10	1.75±0.10	3.50±0.10	4.00±0.10	4.00±0.10	2.00±0.10	1.55±0.05	0.43±0.10	
PA1206	1.90±0.20	3.50±0.20	8.00±0.20	1.75±0.10	3.50±0.50	4.00±0.10	4.00±0.10	2.00±0.05	1.50±0.10	0.75+0.20/-0	



EMBOSSED TAPE

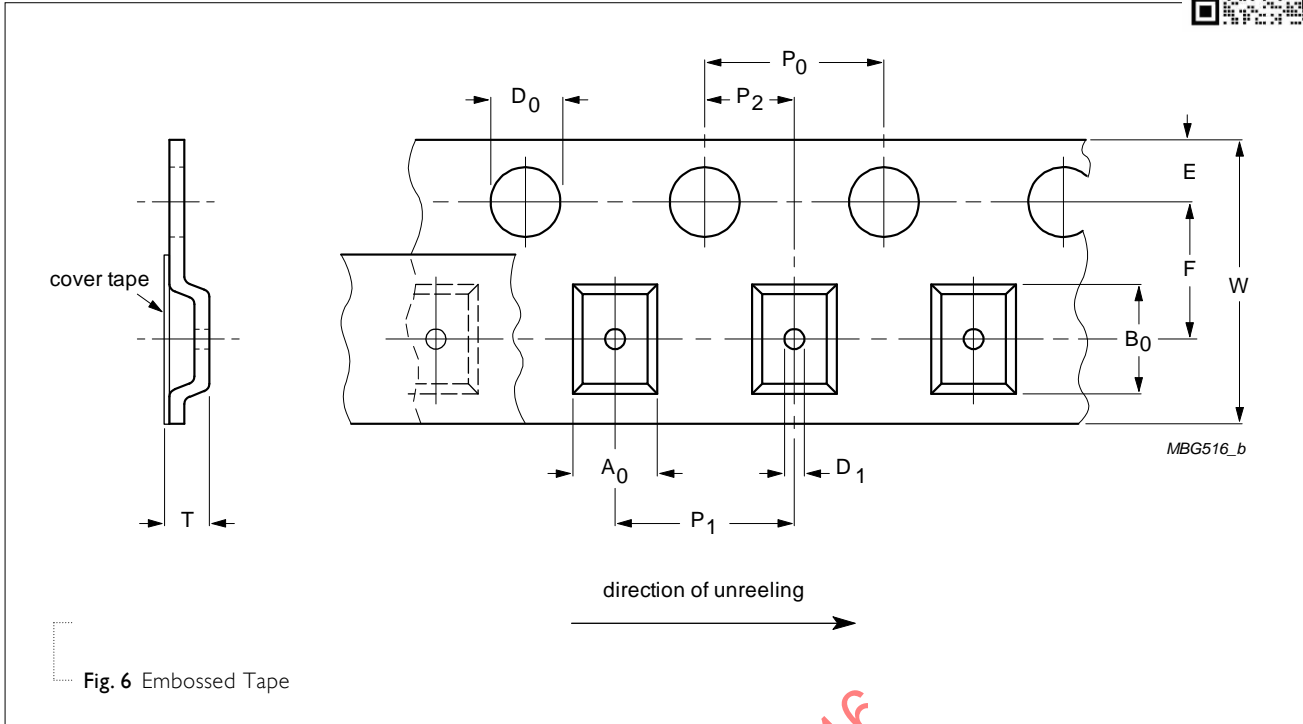


Fig. 6 Embossed Tape

Table 5 Dimensions of embossed tape for relevant chip resistors size

SIZE	SYMBOL										Unit: mm
	A ₀	B ₀	W	E	F	P ₀	P ₁	P ₂	ΦD ₀	ΦD ₁	
PA2010	3.40±0.15	6.70±0.15	12.0±0.30	1.75±0.10	5.50±0.10	4.00±0.10	4.00±0.10	2.00±0.10	1.50±0.10	1.50±0.10	0.80±0.15

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REEL SPECIFICATION

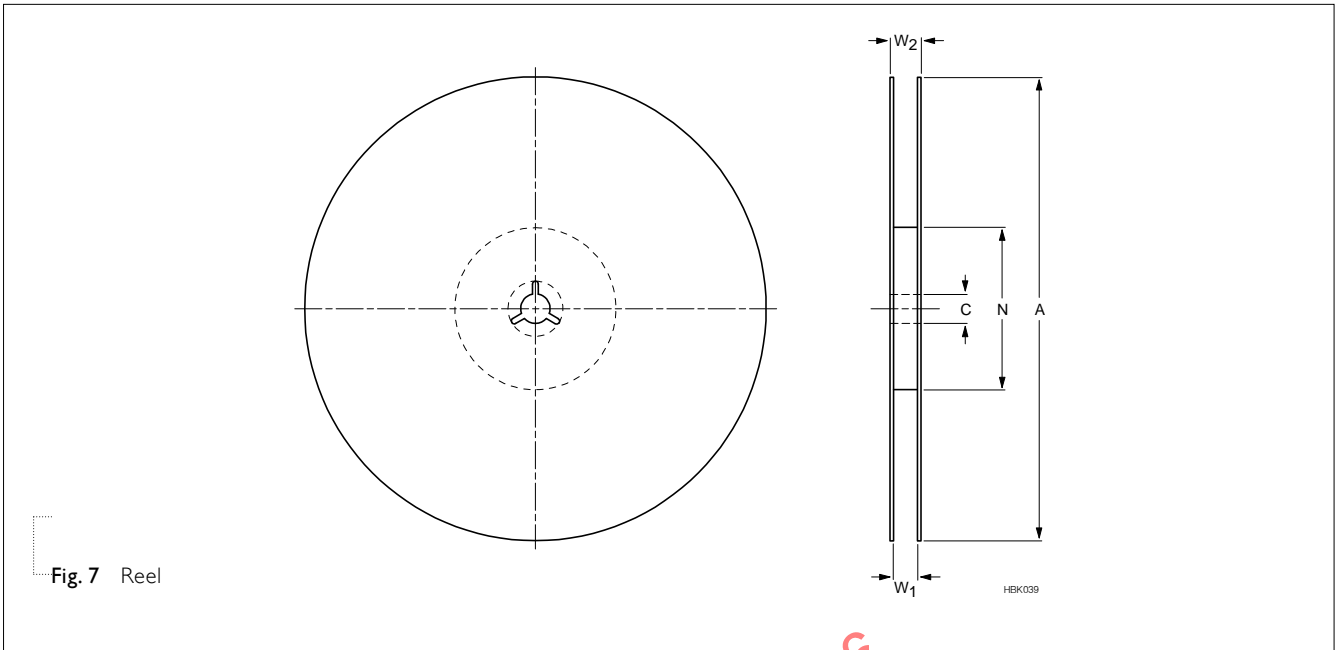


Table 6 Dimensions of reel specification for relevant chip resistors size

SIZE	QUANTITY PER REEL	REEL SIZE		SYMBOL	Unit: mm				
		8 mm TAPE WIDE	12 mm TAPE WIDE		A	N	C	D	W ₁
PA0100	20,000	7" (Ø 178 mm)	---	180.0+0/-3.0	60.0+1/-0	13.0± 0.2	21.0± 0.8	9.0± 0.3	11.4± 1.0
PA0201	10,000	7" (Ø 178 mm)	---	178.0± 1.0	60.0+1/-0	13.5± 0.5	21.0± 0.8	9.0± 0.5	12.0± 0.2
PA0402	10,000	7" (Ø 178 mm)	---	178.0± 1.0	60.0+1/-0	13.5± 0.5	21.0± 0.8	9.0± 0.5	12.0± 0.2
PA0603	5,000	7" (Ø 178 mm)	---	178.0± 1.0	60.0+1/-0	13.5± 0.5	21.0± 0.8	9.0± 0.5	12.0± 0.2
PA0805	5,000	7" (Ø 178 mm)	---	178.0± 1.0	60.0+1/-0	13.5± 0.5	21.0± 0.8	9.0± 0.5	12.0± 0.2
PA1206	4,000	7" (Ø 178 mm)	---	178.0± 1.0	60.0+1/-0	13.5± 0.5	21.0± 0.8	9.0± 0.5	12.0± 0.2
PA2010	4,000	---	7" (Ø 178 mm)	178.0± 1.0	60.0+1/-0	13.5± 0.5	21.0± 0.8	13.6± 0.5	16.5± 0.5

LEADER/TRAILER TAPE SPECIFICATION

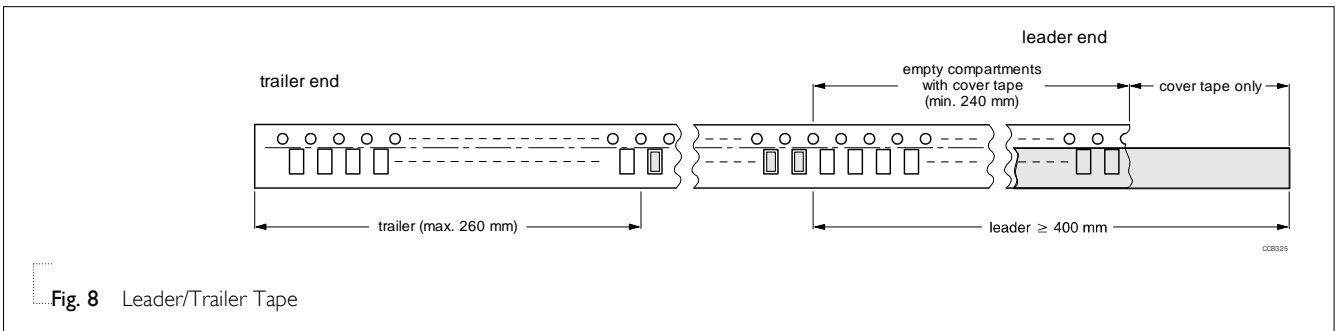


Fig. 8 Leader/Trailer Tape



FOOTPRINT AND SOLDERING PROFILES

For recommended soldering profiles, please refer to data sheet “Chip resistors mounting”.

FOOTPRINT

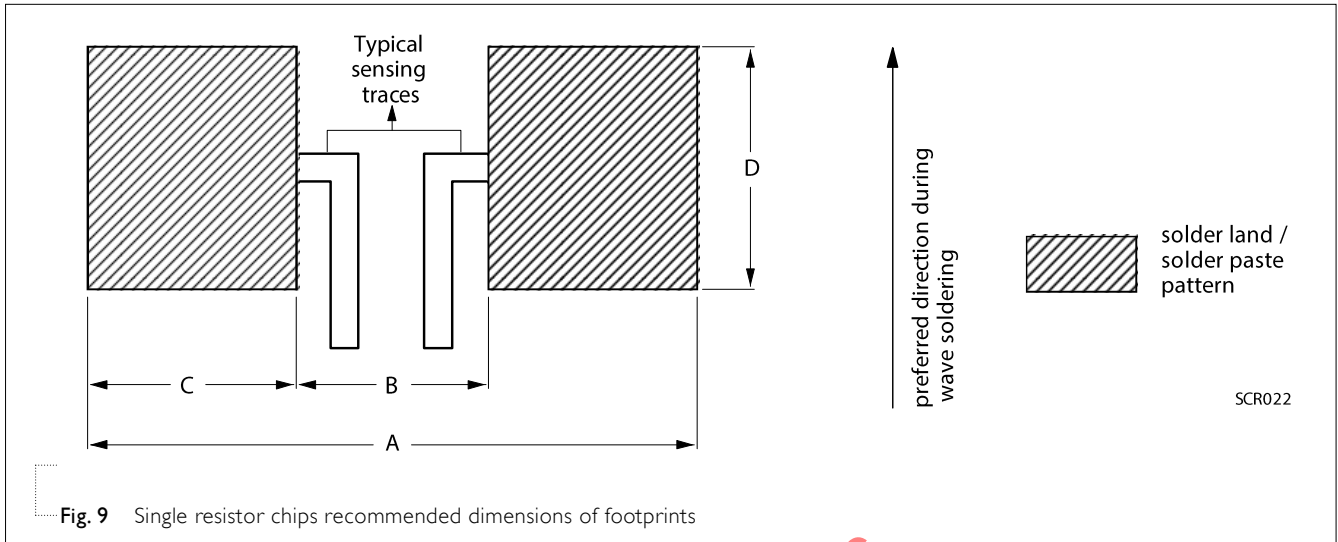


Fig. 9 Single resistor chips recommended dimensions of footprints

Table 7 Footprint dimensions

Unit: mm

SIZE	A	B	C	D
PA0100	0.5~0.8	0.16~0.2	0.17~0.3	0.2~0.4
PA0201	1.0	0.3	0.35	0.4
PA0402	2.0	0.4	0.8	0.6
PA0603	2.2	0.8	0.7	0.9
PA0805	3.4	0.8	1.3	1.3
PA1206	4.0	1.0	1.5	1.8
PA2010	6.0	3.5	1.25	3.0

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TESTS AND REQUIREMENTS

Table 8 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENT
Life/ Endurance	MIL-STD-202 Method 108	1,000 hours at 70±2°C applied RCWV	0100 : < 2mΩ
	IEC 60115-1 4.25.1	1.5 hours on, 0.5 hour off, still air required	0201 : < 5mΩ 0402 : < 1mΩ < 0.5mΩ Others : < 0.2mΩ
High Temperature Exposure/ Endurance at upper category temperature	MIL-STD-202 Method 108	1,000 hours, unpowered at	0100 : < 2mΩ
	IEC 60115-1 4.25.3	0100/ 0201/ 0402 : 125±5°C 0603/ 0805 : 155±5°C 1206/ 2010 : 170±5°C	0201 : < 5mΩ 0402 : < 1mΩ < 0.5mΩ Others : < 0.2mΩ
Moisture Resistance	MIL-STD-202 Method 106	Each temperature / humidity cycle is defined at 8 hours (Method 106G), 3 cycles / 24 hours for 10d. with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, un-powered Parts mounted on test board, without condensation on parts Measurement at 24±2 hours after test conclusion.	0100 : < 2mΩ 0201 : < 5mΩ 0402 : < 1mΩ < 0.5mΩ Others : < 0.2mΩ No visible damage
Thermal Shock	MIL-STD-202 Method 107	-55/+125°C Note : Number of cycles required is 300. Parts mounted on test board. Maximum transfer time is 20 seconds. Dwell time is 15 minutes.	0100 : < 2mΩ 0201 : < 5mΩ 0402 : < 1mΩ < 0.5mΩ Others : < 0.2mΩ
Short time overload	IEC 60115-1 4.13	5 times rated power for 5 seconds.	0100 : < 2mΩ 0201 : < 5mΩ 0402 : < 1mΩ < 0.5mΩ Others : < 0.2mΩ No visible damage
Board Flex/ Bending	IEC 60115-1 4.33	Device mounted on PCB test board as described, only 1 board bending required Bending for 0100 : 5mm 0201 : 3 mm 0402 and above: 2mm Bending time: 60±1 seconds Ohmic value checked during bending	0100 : < 2mΩ 0201 : < 5mΩ 0402 : < 1mΩ < 0.5mΩ Others : < 0.2mΩ



TEST	TEST METHOD	PROCEDURE	REQUIREME
Solderability - Wetting	IPC/JEDEC J-STD-002B test B	Electrical Test not required Magnification 50X SMD conditions: 1st step : Method B, aging 4 hours at 155°C dry heat 2nd step : lead free solder bath at 245±3°C Dipping time : 3±0.5 seconds	Well tinned (>95% covered) No visible damage
- Leaching	IPC/JEDEC J-STD-002B test D	Lead free solder, 260°C, 30 seconds immersion time	No visible damage
- Resistance to Soldering Heat	MIL-STD-202 Method 210 IEC 60115-1 4.18	Condition B, no pre-heat of samples Lead free solder, 260±5°C, 10±1 seconds immersion time Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	0100 : < 2mΩ 0201: < 5mΩ 0402: < 1mΩ < 0.5mΩ Others : < 0.2mΩ No visible damage

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REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 1	Jan. 27, 2021	-	- Add sizes of PA0100, PA1206 and PA2010
Version 0	Oct. 05, 2018	-	- Metal low ohmic jumper - PA series

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